

# XR1009, XR2009

## 0.2mA, 35MHz Rail-to-Rail Amplifiers

## **General Description**

The XR1009 (single) and XR2009 (dual) are ultra-low power, low cost, voltage feedback amplifiers. These amplifiers use only 208µA of supply current and are designed to operate from a supply range of 2.5V to 5.5V (±1.25 to ±2.75). The input voltage range extends 300mV below the negative rail and 1.2V below the positive rail.

The XR1009 and XR2009 offer superior dynamic performance with a 35MHz small signal bandwidth and 27V/µs slew rate. The combination of low power, high bandwidth, and rail-to-rail performance make the XR1009 and XR2009 well suited for battery-powered communication/ computing systems.

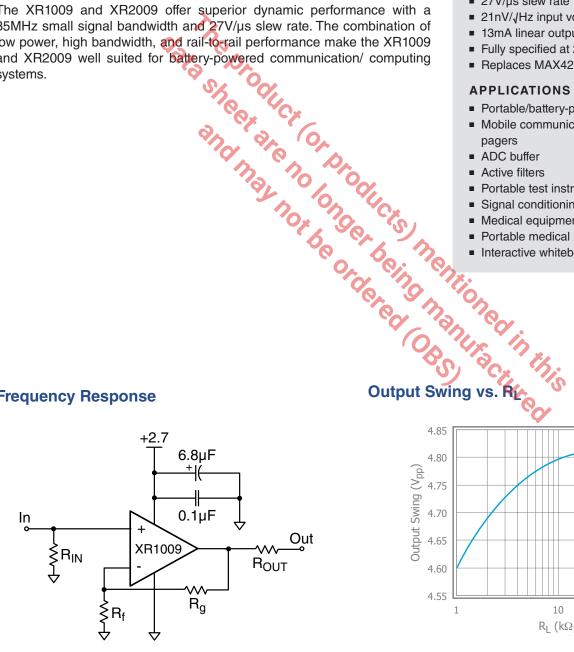
#### **FEATURES**

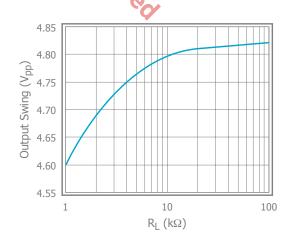
- 208µA supply current
- 35MHz bandwidth
- Input voltage range with 5V supply: -0.3V to 3.8V
- Output voltage range with 5V supply: 0.08V to 4.88V
- 27V/µs slew rate
- 21nV/JHz input voltage noise
- 13mA linear output current
- Fully specified at 2.7V and 5V supplies
- Replaces MAX4281

- Portable/battery-powered applications
- Mobile communications, cell phones,

- Portable test instruments
- Signal conditioning
- Medical equipment
- Portable medical instrumentation
- Interactive whiteboards

## **Frequency Response**





#### **Absolute Maximum Ratings**

Stresses beyond the limits listed below may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

V <sub>S</sub>	0V to 6V
V <sub>IN</sub>	$-V_S$ - 0.5V to $+V_S$ +0.5V
Continuous Output Current	30mA to +30mA

### **Operating Conditions**

Supply Voltage Range	2.5 to 5.5V
Operating Temperature Range	40°C to 125°C
Junction Temperature	150°C
Storage Temperature Range	65°C to 150°C
Lead Temperature (Soldering, 10s)	260°C

### **Package Thermal Resistance**

rent30mA to +30mA	θ <sub>JA</sub> (TSOT23-5)	215°C/W
	θ <sub>JA</sub> (SOIC-8)	150°C/W
	θ <sub>JA</sub> (MSOP-8)	200°C/W
data sheet are no long and may not be ord	Package thermal resistance $(\theta_{JA})$ , JEDEC stest boards, still air.	
Pro Pro	ESD Protection	
S/2 0/1	XR1009 (HBM)	2kV
60° C*	XR2009 (HBM)	
0, 0	ESD Rating for HBM (Human Body Model).	
May to the	, ,	
12 12 10 PM		
A CO	<b>%.</b>	
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XR1009 (HBM)	2kV
XR2009 (HBM)	2.5kV
ESD Rating for HBM (Human Body Model).	

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## **Electrical Characteristics at +2.7V**

 $T_A=25^{\circ}C,\,V_S=+2.7V,\,R_f=R_g=2.5k\Omega,\,R_L=2k\Omega\text{ to }V_S/2;\,G=2;\,\text{unless otherwise noted}.$ 

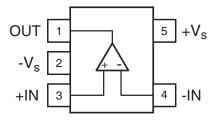
Symbol	Parameter	Conditions	Min	Тур	Max	Units		
Frequency D	Frequency Domain Response							
UGBW <sub>SS</sub>	Unity Gain -3dB Bandwidth	$G = +1, V_{OUT} = 0.05V_{pp}, R_f = 0$		28		MHz		
BW <sub>SS</sub>	-3dB Bandwidth	$G = +2, V_{OUT} < 0.2V_{pp}$		15		MHz		
BW <sub>LS</sub>	Large Signal Bandwidth	$G = +2$ , $V_{OUT} = 2V_{pp}$		7		MHz		
GBWP	Gain Bandwidth Product	$G = +11, V_{OUT} = 0.2V_{pp}$		16		MHz		
Time Domai	n Response							
t <sub>R</sub> , t <sub>F</sub>	Rise and Fall Time	V <sub>OUT</sub> = 0.2V step; (10% to 90%)		16		ns		
t <sub>S</sub>	Settling Time to 0.1%	V <sub>OUT</sub> = 1V step		140		ns		
OS	Overshoot	V <sub>OUT</sub> = 1V step		1		%		
SR	Slew Rate	G = -1, 2V step		20		V/µs		
Distortion/No	pise Response							
HD2	2nd Harmonic Distortion	100kHz, V <sub>OUT</sub> = 1V <sub>pp</sub>		-85		dBc		
HD3	3rd Harmonic Distortion	100kHz, V <sub>OUT</sub> = 1V <sub>pp</sub>		-63		dBc		
THD	Total Harmonic Distortion	100kHz, V <sub>OUT</sub> = 1V <sub>pp</sub>		62		dB		
e <sub>n</sub>	Input Voltage Noise	>10kHz		23		nV/√Hz		
XTALK	Crosstalk	$100kHz$ , $V_{OUT} = 0.2V_{pp}$		98		dB		
DC Performa	ance	0.0	,	,	,	,		
V <sub>IO</sub>	Input Offset Voltage	70 0		0.8		mV		
d <sub>VIO</sub>	Average Drift	6 9/1		11		μV/°C		
I <sub>B</sub>	Input Bias Current	2- 20 Cx		0.37		μΑ		
dl <sub>B</sub>	Average Drift	10 C		1		nA/°C		
Ios	Input Offset Current	00 1/4 /2		8		nA		
PSRR	Power Supply Rejection Ratio	DC O	56	60		dB		
A <sub>OL</sub>	Open Loop Gain	V <sub>OUT</sub> = V <sub>S</sub> / 2		65		dB		
Is	Supply Current	per channel		185		μΑ		
Input Charac	cteristics	PO 12 102						
R <sub>IN</sub>	Input Resistance	Non-inverting	•	>10		ΜΩ		
C <sub>IN</sub>	Input Capacitance	100	7	1.4		pF		
CMIR	Common Mode Input Range	N. 80%	, This	-0.3 to 1.5		V		
CMRR	Common Mode Rejection Ratio	DC, $V_{CM} = 0V$ to $V_S - 1.5V$	6	92		dB		
Output Char	acteristics		0					
V	Output Voltage Swing	$R_L = 2k\Omega$ to $V_S / 2$		0.08 to 2.6		V		
V <sub>OUT</sub>	Output Voltage Swing	$R_L = 10k\Omega$ to $V_S / 2$		0.06 to 2.62		V		
I <sub>OUT</sub>	Output Current			±8		mA		
I <sub>SC</sub>	Short Circuit Current			±12.5		mA		

## **Electrical Characteristics at +5V**

 $T_A$  = 25°C,  $V_S$  = +5V,  $R_f$  =  $R_g$  = 2.5k $\Omega$ ,  $R_L$  = 2k $\Omega$  to  $V_S/2;$  G = 2; unless otherwise noted.

Symbol	Parameter	Conditions	Min	Тур	Max	Units			
Frequency I	Frequency Domain Response								
UGBW <sub>SS</sub>	Unity Gain -3dB Bandwidth	$G = +1, V_{OUT} = 0.05V_{pp}, R_f = 0$		35		MHz			
BW <sub>SS</sub>	-3dB Bandwidth	G = +2, V <sub>OUT</sub> < 0.2V <sub>pp</sub>		18		MHz			
BW <sub>LS</sub>	Large Signal Bandwidth	$G = +2$ , $V_{OUT} = 2V_{pp}$		8		MHz			
GBWP	Gain Bandwidth Product	$G = +11, V_{OUT} = 0.2V_{pp}$		20		MHz			
Time Doma	in Response					,			
t <sub>R</sub> , t <sub>F</sub>	Rise and Fall Time	V <sub>OUT</sub> = 0.2V step; (10% to 90%)		13		ns			
ts	Settling Time to 0.1%	V <sub>OUT</sub> = 1V step		140		ns			
OS	Overshoot	V <sub>OUT</sub> = 1V step		1		%			
SR	Slew Rate	G = -1, 2V step		27		V/µs			
Distortion/N	oise Response								
HD2	2nd Harmonic Distortion	100kHz, V <sub>OUT</sub> = 2V <sub>pp</sub>		-78		dBc			
HD3	3rd Harmonic Distortion	100kHz, V <sub>OUT</sub> = 2V <sub>pp</sub>		-66		dBc			
THD	Total Harmonic Distortion	100kHz, V <sub>OUT</sub> = 2V <sub>pp</sub>		65		dB			
e <sub>n</sub>	Input Voltage Noise	>10kHz		21		nV/√Hz			
XTALK	Crosstalk	100kHz, $V_{OUT} = 0.2V_{pp}$		98		dB			
DC Perform	ance	0.0							
V <sub>IO</sub>	Input Offset Voltage	70 0	-5	-1.5	5	mV			
d <sub>VIO</sub>	Average Drift			20		μV/°C			
I <sub>B</sub>	Input Bias Current	12 12 Cx	-1.3	0.37	1.3	μA			
dl <sub>B</sub>	Average Drift	0, 00		1		nA/°C			
Ios	Input Offset Current	00 4 12		7	130	nA			
PSRR	Power Supply Rejection Ratio	DC O	56	60		dB			
A <sub>OL</sub>	Open Loop Gain	V <sub>OUT</sub> = V <sub>S</sub> / 2	56	62		dB			
Is	Supply Current	per channel		208	260	μA			
Input Chara	cteristics	Co 12 102							
R <sub>IN</sub>	Input Resistance	Non-inverting		>10		ΜΩ			
C <sub>IN</sub>	Input Capacitance		7	1.2		pF			
CMIR	Common Mode Input Range	N. 80%	his	-0.3 to 3.8		V			
CMRR	Common Mode Rejection Ratio	DC, $V_{CM} = 0V$ to $V_S - 1.5V$	65	95		dB			
Output Cha	racteristics		9			,			
V	Outrot Vallage Outrag	$R_L = 2k\Omega$ to $V_S/2$	0.2 to 4.7	0.1 to 4.8		V			
V <sub>OUT</sub>	Output Voltage Swing	$R_L = 10k\Omega$ to $V_S / 2$		0.08 to 4.88		V			
I <sub>OUT</sub>	Output Current			±8.5		mA			
I <sub>SC</sub>	Short Circuit Current			±13	<u> </u>	mA			

## **XR1009 Pin Configurations** TSOT-5

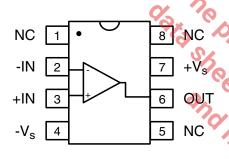


## **XR1009 Pin Assignments**

#### TSOT-5

	Pin No.	Pin Name	Description
	1	OUT	Output
	2	-V <sub>S</sub>	Negative supply
	3	+IN	Positive input
	4	-IN	Negative input
Ì	5	+V <sub>S</sub>	Positive supply

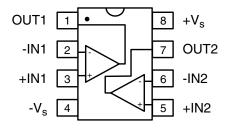
#### **SOIC-8**



#### **SOIC-8**

70	Pin No.	Pin Name	Description
NC O	1	NC	No Connect
	2	-IN	Negative input
] +V <sub>s</sub>	3	+IN	Positive input
T ONT	4	-V <sub>S</sub>	Negative supply
J OUT	5	NC	No Connect
] NC	6	OUT	Output
73. 76	70	+V <sub>S</sub>	Positive supply
<b>1</b>	8	NC	No Connect
10 <sub>2</sub>	be of b	on then	
on	XR2009 P	in Assignme	ents
	SOIC-8 / MS		ed.
	Pin No.	Pin Name	Description

## **XR2009 Pin Configuration** SOIC-8 / MSOP-8



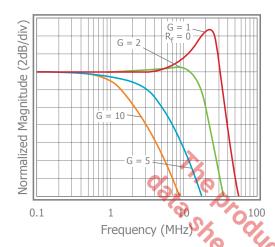
# XR2009 Pin Assignments

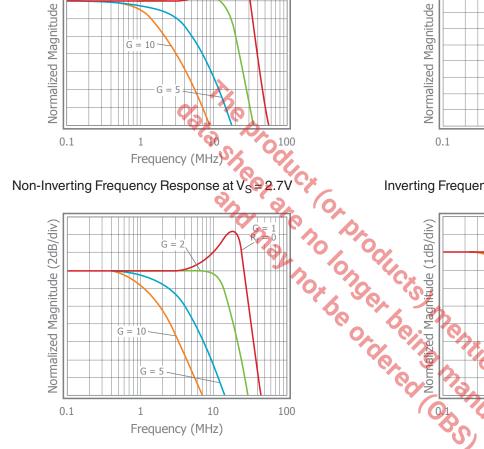
Pin No.	Pin Name	Description	
1	OUT	Output, channel 1	
2	-IN1	Negative input, channel 1	
3	+IN1	Positive input, channel 1	
4	-V <sub>S</sub>	Negative supply	
5	+IN2	Positive input, channel 2	
6	-IN2	Negative input, channel 2	
7	OUT2	Output, channel 2	
8	+V <sub>S</sub>	Positive supply	

## **Typical Performance Characteristics**

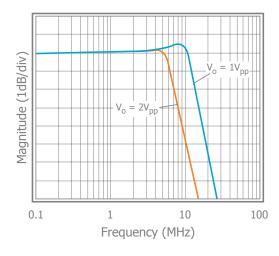
 $T_A = 25^{\circ}C$ ,  $V_S = +5V$ ,  $R_f = R_g = 2.5k\Omega$ ,  $R_L = 2k\Omega$  to  $V_S/2$ ; G = 2; unless otherwise noted.

Non-Inverting Frequency Response at  $V_S = 5V$ 

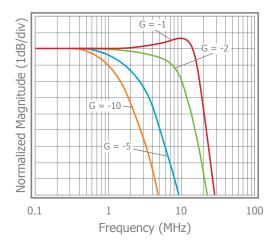




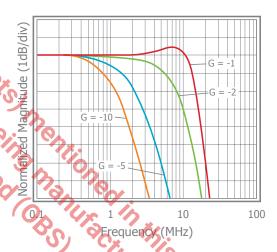
Frequency Response vs. VOUT



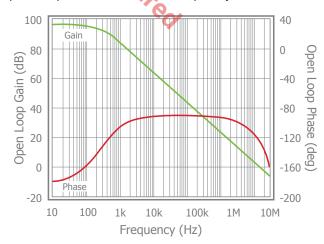
Inverting Frequency Response at  $V_S = 5V$ 



Inverting Frequency Response at V<sub>S</sub> = 2.7V



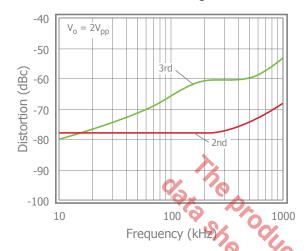
Open Loop Gain & Phase vs. Frequency



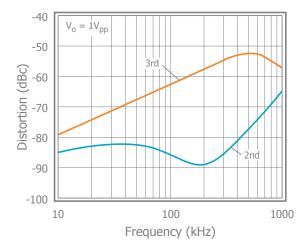
## **Typical Performance Characteristics**

 $T_A = 25^{\circ}C$ ,  $V_S = +5V$ ,  $R_f = R_g = 2.5k\Omega$ ,  $R_L = 2k\Omega$  to  $V_S/2$ ; G = 2; unless otherwise noted.

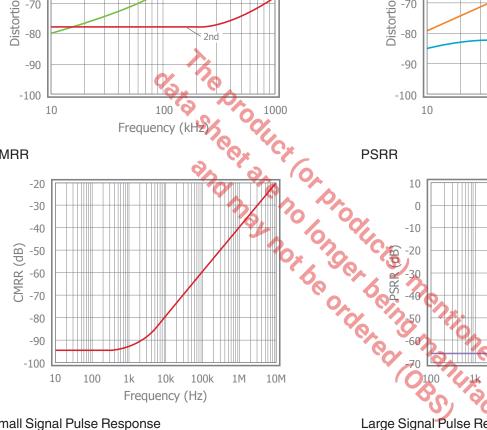
#### 2nd & 3rd Harmonic Distortion at $V_S = 5V$

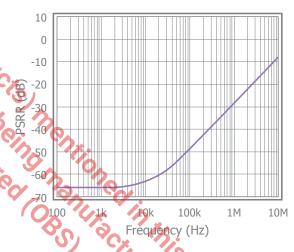


#### 2nd & 3rd Harmonic Distortion at $V_S = 2.7V$

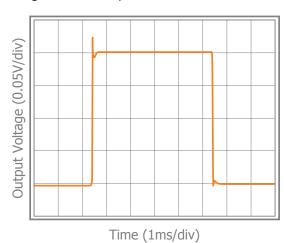


#### **CMRR**

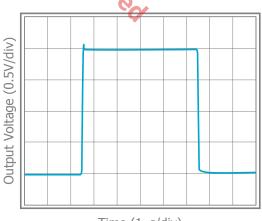




#### Small Signal Pulse Response



Large Signal Pulse Response



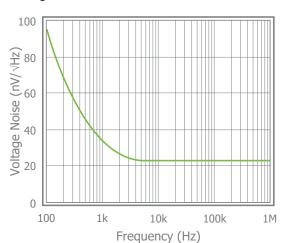
## **Typical Performance Characteristics**

 $T_A = 25^{\circ}C$ ,  $V_S = +5V$ ,  $R_f = R_q = 2.5k\Omega$ ,  $R_L = 2k\Omega$  to  $V_S/2$ ; G = 2; unless otherwise noted.

#### Output Swing vs. RL



#### Input Voltage Noise



RL (KΩ) Sheet of the products of the products

#### **Application Information**

#### **General Description**

The XR1009 and XR2009 are a single supply, general purpose, voltage-feedback amplifiers fabricated on a complementary bipolar process. The XR1009 offers 35MHz unity gain bandwidth, 27V/µs slew rate, and only 208µA supply current. It features a rail-to-rail output stage and is unity gain stable.

The design utilizes a patent pending topology that provides increased slew rate performance. The common mode input range extends to 300mV below ground and to 1.2V below Vs. Exceeding these values will not cause phase reversal. However, if the input voltage exceeds the rails by more than 0.5V, the input ESD devices will begin to conduct. The output will stay at the rail during this overdrive condition.

The design uses a Darlington output stage. The output stage is short circuit protected and offers "soft" saturation protection that improves recovery time.

Figures 1, 2, and 3 illustrate typical circuit configurations for non-inverting, inverting, and unity gain topologies for dual supply applications. They show the recommended bypass capacitor values and overall closed loop gain equations. Figure 4 shows the typical non-inverting gain circuit for single supply applications.

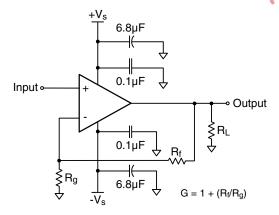


Figure 1: Typical Non-Inverting Gain Circuit

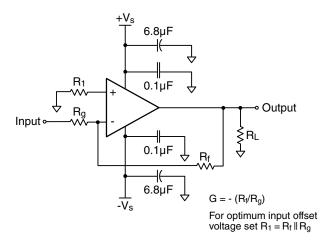
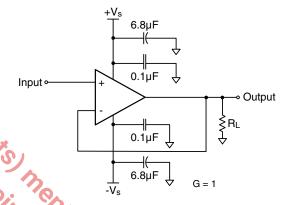


Figure 2: Typical Inverting Gain Circuit



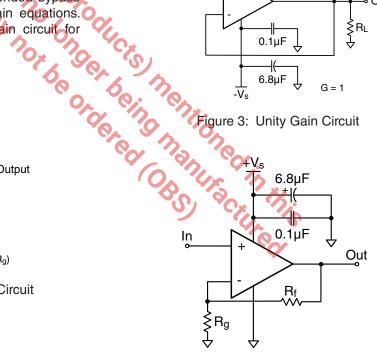


Figure 4: Single Supply Non-Inverting Gain Circuit

#### **Power Dissipation**

Power dissipation should not be a factor when operating under the stated  $2k\Omega$  load condition. However, applications with low impedance, DC coupled loads should be analyzed to ensure that maximum allowed junction temperature is not exceeded. Guidelines listed below can be used to verify that the particular application will not cause the device to operate beyond it's intended operating range.

Maximum power levels are set by the absolute maximum junction rating of 150°C. To calculate the junction temperature, the package thermal resistance value Theta<sub>JA</sub>  $(\theta, IA)$  is used along with the total die power dissipation.

$$T_{Junction} = T_{Ambient} + (\theta_{JA} \times P_{D})$$

Where T<sub>Ambient</sub> is the temperature of the working environment.

In order to determine P<sub>D</sub>, the power dissipated in the load needs to be subtracted from the total power delivered by the supplies.

$$P_D = P_{supply} - P_{load}$$

Supply power is calculated by the standard power equation.

$$P_{\text{supply}} = V_{\text{supply}} \times I_{\text{RMSsupply}}$$
 $V_{\text{supply}} = V_{\text{S+}} - V_{\text{S-}}$ 

Power delivered to a purely resistive load is:

$$P_{load} = ((V_{load})_{RMS^2})/Rload_{eff}$$

The effective load resistor (Rload<sub>eff</sub>) will need to include the effect of the feedback network. For instance,

Rload<sub>eff</sub> in Figure 3 would be calculated as:

$$R_L \parallel (R_f + R_a)$$

These measurements are basic and are relatively easy to perform with standard lab equipment. For design purposes however, prior knowledge of actual signal levels and load impedance is needed to determine the dissipated power. Here,  $P_{\rm D}$  can be found from

$$P_D = P_{Ouiescent} + P_{Dynamic} - P_{load}$$

Quiescent power can be derived from the specified  $I_S$  values along with known supply voltage,  $V_{supply}$ . Load power can be calculated as above with the desired signal amplitudes using:

$$(V_{load})_{RMS} = V_{peak} / \sqrt{2}$$

$$(I_{load})_{RMS} = (V_{load})_{RMS} / Rload_{eff}$$

The dynamic power is focused primarily within the output stage driving the load. This value can be calculated as:

$$P_{Dynamic} = (V_{S+} - V_{load})_{RMS} \times (I_{load})_{RMS}$$

Assuming the load is referenced in the middle of the power rails or  $V_{\text{supply}}/2$ .

The XR1009 is short circuit protected. However, this may not guarantee that the maximum junction temperature (+150°C) is not exceeded under all conditions. Figure 5 shows the maximum safe power dissipation in the package vs. the ambient temperature for the packages available.

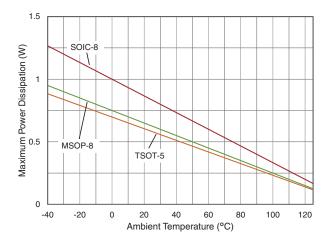


Figure 5. Maximum Power Derating

# **Driving Capacitive Loads**

Increased phase delay at the output due to capacitive loading can cause ringing, peaking in the frequency response, and possible unstable behavior. Use a series resistance, R<sub>S</sub>, between the amplifier and the load to help improve stability and settling performance. Refer to Figure 6.

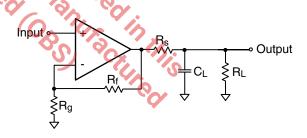


Figure 6. Addition of R<sub>S</sub> for Driving Capacitive Loads

#### **Overdrive Recovery**

For an amplifier, an overdrive condition occurs when the output and/or input ranges are exceeded. The recovery time varies based on whether the input or output is overdriven and by how much the ranges are exceeded. The XR1009, and XR2009 will typically recover in less than 20ns from an overdrive condition.

#### **Layout Considerations**

General layout and supply bypassing play major roles in high frequency performance. Exar has evaluation boards to use as a guide for high frequency layout and as an aid in device testing and characterization. Follow the steps below as a basis for high frequency layout:

- Include 6.8µF and 0.1µF ceramic capacitors for power supply decoupling
- Place the 6.8µF capacitor within 0.75 inches of the power pin
- Place the 0.1µF capacitor within 0.1 inches of the power pin
- Remove the ground plane under and around the part, especially near the input and output pins to reduce parasitic capacitance
- Minimize all trace lengths to reduce series inductances

Refer to the evaluation board layouts below for more information.

#### **Evaluation Board Information**

The following evaluation boards are available to aid in the testing and layout of these devices:

Evaluation Board #	Products
CEB002	XR1009 in TSOT
CEB003	XR1009 in SOIC
CEB006	XR2009 in SOIC
CEB010	XR2009 in MSOP

#### **Evaluation Board Schematics**

Evaluation board schematics and layouts are shown in Figures 9-18 These evaluation boards are built for dual-supply operation. Follow these steps to use the board in a single-supply application:

- 1. Short -V<sub>S</sub> to ground.
- 2. Use C3 and C4, if the  $-V_S$  pin of the amplifier is not directly connected to the ground plane.

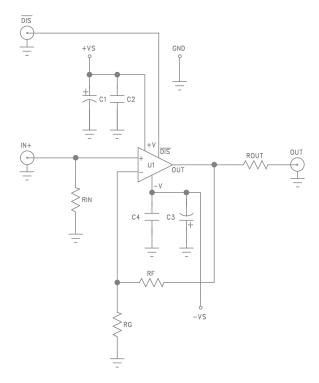


Figure 9. CEB002 & CEB003 Schematic

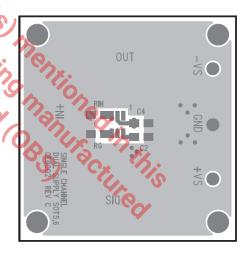


Figure 10. CEB002 Top View

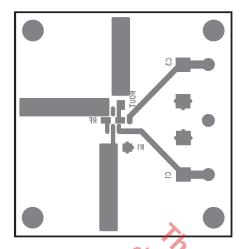


Figure 11. CEB002 Bottom View

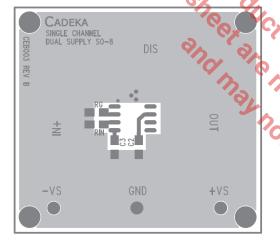


Figure 12. CEB003 Top View

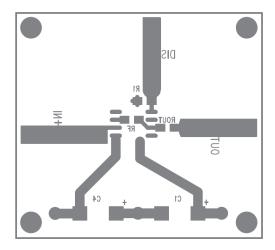


Figure 13. CEB003 Bottom View

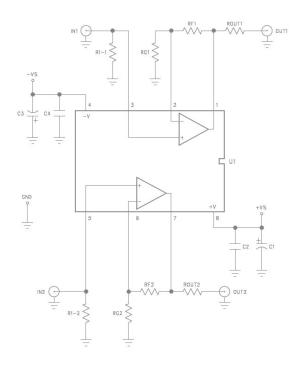


Figure 14. CEB006 & CEB010 Schematic

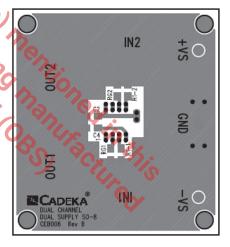


Figure 15. CEB006 Top View

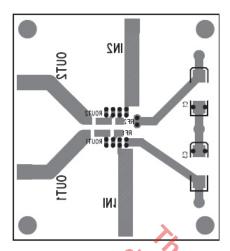


Figure 16. CEB006 Bottom View

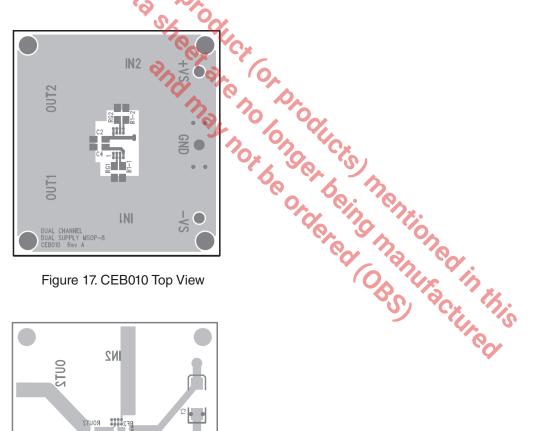


Figure 17. CEB010 Top View

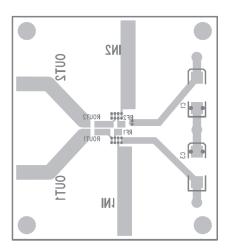
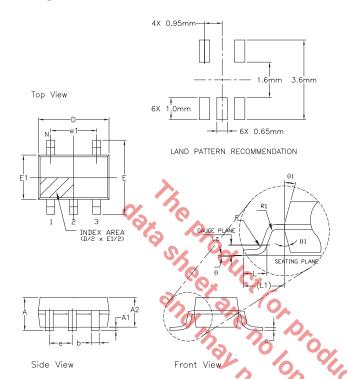


Figure 18. CEB010 Bottom View

#### **Mechanical Dimensions**

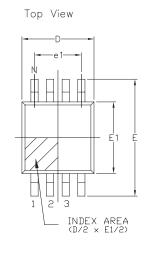
#### **TSOT-5 Package**

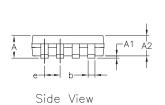


5 Pin TSOT (OPTION 2)							
SYMBOLS	DIMENSION IN MM (Control Unit)			DIMENSION IN INCH (Reference Unit)			
	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.75	_	0.80	0.030	_	0.031	
A1	0.00	_	0.05	0.000	_	0.002	
A2	0.70	0.75	0.78	0.028	0.030	0.031	
b	0.35	_	0.50	0.012	_	0.020	
С	0.10	_	0.20	0.003	_	0.008	
D	2	2.90 BS	iC .	0.114 BSC			
E	2	2.80 BS	SC .	0.110 BSC			
E1	1	.60 BS	iC .	0.063 BSC			
е	(	).95 BS	iC .	0.038 BSC			
e1	1	.90 BS	SC .	0	0.075 B	SC	
L	0.37	0.45	0.60	0.012	0.018	0.024	
L1	(	0.60 RE	F	0.024 REF		F	
L2	(	0.25 BS	C	0	.010 BS	C	
R	0.10	_	—	0.004	_	_	
R1	0.10	_	0.25	0.004	_	0.010	
θ	0.	4*	8*	0,	4.	8*	
θ1	4*	10°	12*	4*	10°	12*	
N		5			5		

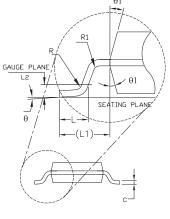
### **MSOP-8 Package**

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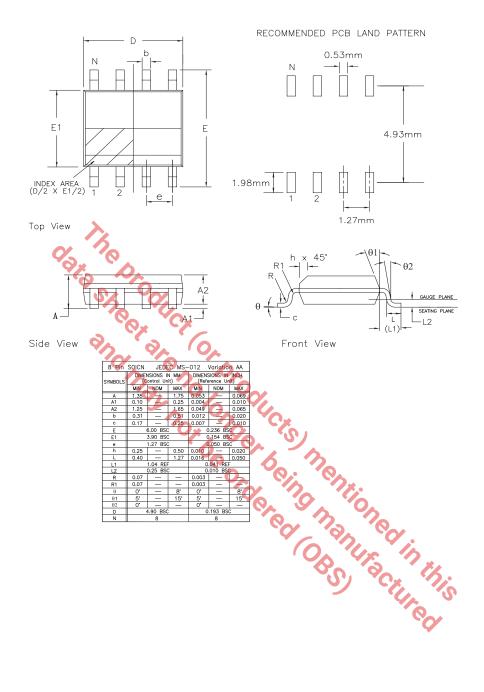






Front View

#### **SOIC-8 Package**



### **Ordering Information**

Part Number	Package	Green	Operating Temperature Range	Packaging Quantity	Marking			
XR1009 Ordering Information								
XR1009IST5X	TSOT-5	Yes	-40°C to +125°C	2.5k Tape & Reel	UC			
XR1009IST5MTR	TSOT-5	Yes	-40°C to +125°C	250 Tape & Reel	UC			
XR1009IST5EVB	Evaluation Board	N/A	N/A	N/A	N/A			
XR1009ISO8X	SOIC-8	Yes	-40°C to +125°C	2.5k Tape & Reel	XR1009			
XR1009ISO8MTR	SOIC-8	Yes	-40°C to +125°C	250 Tape & Reel	XR1009			
XR1009ISO8EVB	Evaluation Board	N/A	N/A	N/A	N/A			
XR2009 Ordering Inform	nation				·			
XR2009ISO8X	SOIC-8	Yes	-40°C to +125°C	2.5k Tape & Reel	XR2009			
XR2009ISO8MTR	SOIC-8	Yes	-40°C to +125°C	250 Tape & Reel	XR2009			
XR2009ISO8EVB	Evaluation Board	N/A	N/A	N/A	N/A			
XR2009IMP8X	MSOP-8	Yes	-40°C to +125°C	2.5k Tape & Reel	2009			
XR2009IMP8MTR	MSOP-8	Yes	-40°C to +125°C	250 Tape & Reel	2009			
XR2009IMP8EVB	Evaluation Board	N/A	N/A	N/A	N/A			
XR2009IMP8EVB Evaluation Board N/A N/A N/A N/A N/A  Moisture sensitivity level for all parts is MSL-1.  Revision History								

## **Revision History**

Revision	Date	Description
1A	June 2014	Initial Release [ECN 1426-101 06/24/14]
1B	Sept 2014	Added XR1009 ESD, increased operating temperature range, updated package outline drawings, and removed Preliminary note on XR1009. [ECN 1436-03   09/04/14]
		OBS) Returnis
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<u>XR2009IMP8X</u> <u>XR2009ISO8EVB</u> <u>XR2009IMP8EVB</u> <u>XR1009ISO8EVB</u> <u>XR1009IST5EVB</u> <u>XR2009IMP8</u> XR2009ISO8 XR1009ISO8